TOSHIBA ALLOY-FREE REVERSE CONDUCTING THYRISTOR

S H R 4 0 0 R 2 2

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage: VDRM=1300V

R.M.S On-State Current $: I_{T(RMS)} = 630A$ Turn-Off Time : $t_{q} = 40 \mu s$ (Max.)

Flat Package

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage	$v_{ m DRM}$	1300	V	
Non-Repetitive Peak Off-State Voltage (Non-Repetitive $< 5 \text{ms}$, $T_j = 0 \sim 115^{\circ}\text{C}$)	$v_{ m DSM}$	1300	v	
R.M.S On-State Current	IT (RMS)	630	A	
R.M.S Reverse Current	IR (RMS)	235		
Average On-State Current	I _T (AV)	400	A	
Average Reverse Current	I _{R (AV)}	150		
Peak One Cycle Surge On-State		7200 (50Hz)	A	
Current (Non-Repetitive)	I_{TSM}	8000 (60Hz)		
Peak One Cycle Surge Reverse	T= 0	2500 (50Hz)		
Current (Non-Repetitive)	I_{RSM}	2750 (60Hz)		
I ² t Limit Value	${f I^2t}$	200×10^{3} (On-Current) 31×10^{3} (Reverse Current)	$ m A^2s$	
Critical Rate of Rise of On-State Current	di/dt	100	A/μs	
Peak Gate Power Dissipation	P_{GM}	20	W	
Average Gate Power Dissipation	P _G (AV)	4	W	
Peak Forward Gate Current	I_{GM}	4	Α	
Peak Forward Gate Voltage	v_{FGM}	20	V	
Peak Reverse Gate Voltage	v_{RGM}	5	V	
Junction Temperature	T_{j}	-40~115	°C	
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~115	°C	
Mounting Force	_	1350~1650	kg	

Unit in mm 2 · \$5.2 ± 0.2 DEPTH 2.0 ± 0.4 (1) - (1) ¢35±0. 260 ± 8 ø35±0.5 CATHODE CATHODE (BLACK) ANODE GATE (WHITE) **JEDEC EIAJ TOSHIBA** 13-78D1A

Weight: 260g

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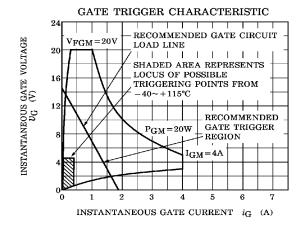
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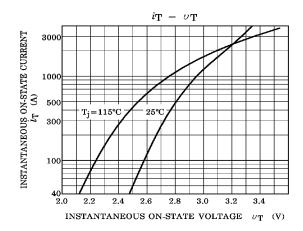
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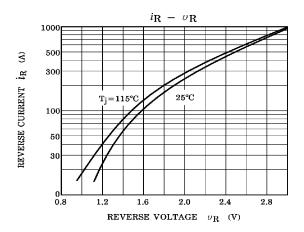
ELECTRICAL CHARACTERISTICS

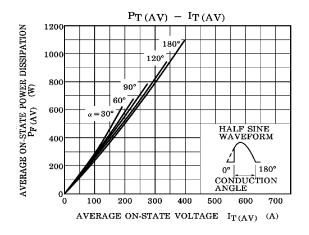
CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current	$I_{ m DRM}$	V _{DRM} =Rated, T _j =115°C		_	35	mA
Peak On-State Voltage	V_{TM}	$I_{TM} = 1250A, T_j = 25^{\circ}C$		_	3.0	v
Peak Reverse Voltage	$v_{\mathbf{RM}}$	$I_{RM} = 500A, T_j = 25^{\circ}C$		_	2.5	1 ' [
Gate Trigger Voltage	v_{GT}		Tc = -40°C		4.5	v
		V6V P60	Tc = 25°C		3.0	
Gate Trigger Current	$V_D=6V, R_L=6\Omega$	VD-6V, KL-622	Tc = -40°C		400	mA
Gate Trigger Current			$Tc = 25^{\circ}C$	_	200	
Gate Non-Trigger Voltage	v_{GD}	V _D =1/2 Rated, T _j =115°C		0.15		V
Gate Non-Trigger Current	$I_{ ext{GD}}$			1.5	_	mA
Delay Time	^t d	V_D =1/2 Rated, T_j =25°C, Gate Supply (V_G =15V, R_G =8 Ω , t_r \leq 1 μ s)		_	4	μs
Gate Turn-On Time	$t_{ m gt}$			_	6	μs
Turn-Off Time	$t_{\mathbf{q}}$	I_{TM} =400A, I_{R} =10A, V_{DRM} =1/2 Rated, $dv/dt(C)$ =200V/ μ s, T_{j} =115°C		_	40	μS
Holding Current	$I_{\mathbf{H}}$	$T_j = 25$ °C, $R_L = 6\Omega$		_	500	mA
Critical Rate of Rise of Commutating OFF-State Voltage	dv/dt(C)	I_{TM} =2000A, I_{RM} =1000A, V_{DRM} =1/2 Rated, Pulse width 60 μ s, T_j =115°C		200	_	V/μs
Thermal Resistance (Junction to Case)	R _{th (j-f)}	DC		_	0.04	°C/W
Critical Rate of Rise of Off- State Voltage	dv/dt	V _D =650V, T _j =115°C, Gate Open, Exponential Rise		1000	_	V/μs

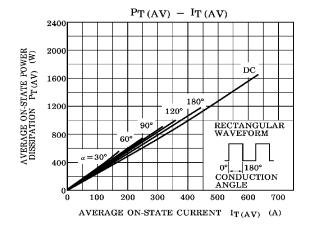


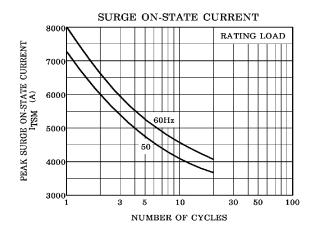


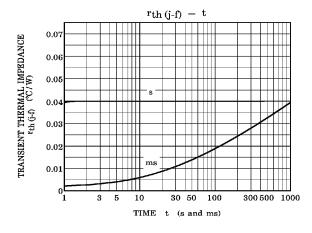
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